



AMENDMENT TRANSMITTAL LETTER

Docket No.
TESSERA 3.0-228

Application No.
09/920,499

Filing Date
August 1, 2001

Examiner
L. Umez-Eronini

Art Unit
1765

Applicant(s): Bobwen Zhong Kong and Masud Beroz

Invention: WET ETCH PROCESS AND COMPOSITION FOR FORMING OPENINGS IN A POLYMER SUBSTRATE

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	15	- 72 =		x	0.00
Independent Claims	2	- 6 =		x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

☒ Large Entity

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Dated: November 12, 2003

Stephen B. Goldman
Attorney Reg. No.: 28,512

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(Stephen B. Goldman)

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Docket No.: TESSERA 3.0-228
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Kong et al.

Application No.: 09/920,499

Filed: August 1, 2001

For: WET ETCH PROCESS AND
COMPOSITION FOR FORMING
OPENINGS IN A POLYMER SUBSTRATE

: Group Art Unit: 1765

: Examiner: L. Umez-Eronini

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Madam:

In response to the Official Action mailed May 21, 2003, Applicants submit the following amendments and remarks.

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